

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
<table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 70%;">Name</th> <th style="width: 30%;">Execution Date</th> </tr> </thead> <tbody> <tr> <td>Zigmund Ramirez Camacho</td> <td>10/28/2009</td> </tr> <tr> <td>Jairus Legaspi Pisigan</td> <td>10/28/2009</td> </tr> <tr> <td>Henry Descalzo Bathan</td> <td>10/28/2009</td> </tr> </tbody> </table>		Name	Execution Date	Zigmund Ramirez Camacho	10/28/2009	Jairus Legaspi Pisigan	10/28/2009	Henry Descalzo Bathan	10/28/2009				
Name	Execution Date												
Zigmund Ramirez Camacho	10/28/2009												
Jairus Legaspi Pisigan	10/28/2009												
Henry Descalzo Bathan	10/28/2009												
RECEIVING PARTY DATA													
<table border="1" style="width: 100%; border-collapse: collapse;"> <tr> <td style="width: 20%;">Name:</td> <td>STATS ChipPAC Ltd.</td> </tr> <tr> <td>Street Address:</td> <td>10 Ang Mo Kio Street 65</td> </tr> <tr> <td>Internal Address:</td> <td>#05-17/20 Techpoint</td> </tr> <tr> <td>City:</td> <td>Singapore</td> </tr> <tr> <td>State/Country:</td> <td>SINGAPORE</td> </tr> <tr> <td>Postal Code:</td> <td>569059</td> </tr> </table>		Name:	STATS ChipPAC Ltd.	Street Address:	10 Ang Mo Kio Street 65	Internal Address:	#05-17/20 Techpoint	City:	Singapore	State/Country:	SINGAPORE	Postal Code:	569059
Name:	STATS ChipPAC Ltd.												
Street Address:	10 Ang Mo Kio Street 65												
Internal Address:	#05-17/20 Techpoint												
City:	Singapore												
State/Country:	SINGAPORE												
Postal Code:	569059												
PROPERTY NUMBERS Total: 1													
<table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 30%;">Property Type</th> <th style="width: 70%;">Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>12608587</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	12608587								
Property Type	Number												
Application Number:	12608587												
CORRESPONDENCE DATA													
<p>Fax Number: (408)738-0881</p> <p><i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Phone: 408-738-0592</p> <p>Email: efiling@ishimarulaw.com</p> <p>Correspondent Name: LAW OFFICES OF MIKIO ISHIMARU</p> <p>Address Line 1: 333 W. EL CAMINO REAL</p> <p>Address Line 2: SUITE 330</p> <p>Address Line 4: SUNNYVALE, CALIFORNIA 94087</p>													
ATTORNEY DOCKET NUMBER:	27-603												
NAME OF SUBMITTER:	Mikio Ishimaru												
Total Attachments: 3													

CH \$40.00 12608587

501023483

PATENT
REEL: 023560 FRAME: 0613

source=27-603_ASSIGNMENT#page1.tif
source=27-603_ASSIGNMENT#page2.tif
source=27-603_ASSIGNMENT#page3.tif

SC-708-253

ASSIGNMENT

WHEREAS, the undersigned (hereinafter termed Assignor(s)) has/have invented certain new and useful improvements in

INTEGRATED CIRCUIT PACKAGING SYSTEM WITH STACKED INTEGRATED CIRCUIT AND METHOD OF MANUFACTURE THEREOF

for which a United States patent application has been executed on or before the date of this assignment;

WHEREAS, STATS ChipPAC Ltd., a Corporation of the Republic of Singapore, having a place of business at 10 Ang Mo Kio Street 65, #05-17/20 Techpoint, Singapore 569059, Republic of Singapore (hereinafter termed Assignee), is desirous of acquiring the entire right, title and interest in and to said application and said invention and improvements thereon, and in and to Letters Patents thereon when granted in the United States and foreign countries;

NOW, THEREFORE, for good and valuable consideration received by said Assignor(s) from said Assignee(s), the receipt of which is hereby acknowledged by said Assignor(s):

1. Said Assignor(s) does hereby sell, assign, transfer and convey unto said Assignee(s), the entire right, title and interest in and to said application and said invention and in and to any and all improvements on said invention and in and to any and all improvements on said invention heretofore or hereafter made or acquired by said Assignor(s); and in and to any and all Letters Patent on said invention and/or said improvements that may be granted in the United States or any foreign country, including each and every Letters Patent granted on any application which is a division, continuation, substitution, renewal, or continuation-in-part of any said application, and in and to each and every reissue or extension of said Letters Patent.
2. Said Assignor(s) hereby covenants and agrees to cooperate with said Assignee(s) where said Assignee(s) may enjoy to the fullest extent the right, title and interest herein conveyed. Such cooperation shall include (a) prompt execution of all papers (prepared at the expense of Assignee(s)) which are deemed necessary or desirable by Assignee(s) to perfect in it the right, title and interest herein conveyed, (b) prompt execution of all petitions, oaths, specifications or other papers (prepared at the expense of Assignee(s)) which are deemed necessary or desirable by Assignee(s) for prosecuting said application, for filing and prosecuting divisional, continuation, substitution, renewal, continuation-in-part, or additional applications in the United States and/or foreign countries covering said invention and/or said improvements, for filing and prosecuting applications for reissuance of letters patent included herein, or for interference proceedings involving said invention and/or said improvements and (c) prompt assistance and cooperation in the prosecution of interference proceedings involving said invention and/or said improvements and in the adjudication of said Letters Patent, particularly by the disclosure of facts and the production of evidence relating to said invention and/or said improvements, provided the expenses which may be incurred by said Assignor(s) in lending such assistance and cooperation shall be paid by the Assignee(s).
3. The terms, covenants and conditions of this assignment shall inure to the benefit of said Assignee(s), its successors, assigns and/or other legal representatives and shall be binding upon said Assignor(s), his/her heirs, legal representatives and assigns.
4. Said Assignor(s) hereby warrants and represents that he/she has not entered into any assignment, contract or understanding in conflict herewith.

5. Said Assignor(s) hereby authorizes and requests the attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow:

Serial Number: 12/608,587 Filing Date: Oct. 29, 2009.

IN WITNESS WHEREOF, the said Assignor has executed and delivered this instrument on the date set forth below.

Zigmond Ramirez Camacho
Zigmond Ramirez Camacho

28 OCT 2009

Date

Dioscoro Merilo
Witness Signature

Huang Rui

Witness Signature

DIOSCORO MERILO

Print Witness Name

HUANG RUI

Print Witness Name

28 OCT. 2009

Date

28 Oct 2009

Date

IN WITNESS WHEREOF, the said Assignor has executed and delivered this instrument on the date set forth below.

Jairus Legaspi Pisigan
Jairus Legaspi Pisigan

28 OCT 2009

Date

Dioscoro Merilo
Witness Signature

Huang Rui

Witness Signature

DIOSCORO MERILO

Print Witness Name

HUANG RUI

Print Witness Name

28 OCT. 2009

Date

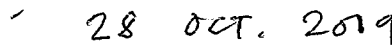
28 Oct 2009

Date

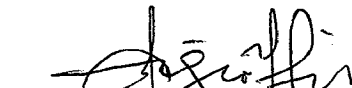
IN WITNESS WHEREOF, the said Assignor has executed and delivered this instrument on the date set forth below.



Henry Descalzo Bathan

 28 OCT. 2009

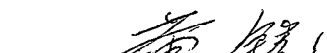
Date



Witness Signature

DIOSCORO MERILO

Print Witness Name



Witness Signature

HUANG RUI

Print Witness Name

28 OCT. 2009

Date

28 OCT 2009

Date